

BIJU PATNAIK UNIVERSITY OF TECHNOLOGY, ODISHA

Tender Notice

Package Code: TEQIP-III/OD/bpuo/21

Package Name: BPUT/Odisha/G-17

Current Date: 06-Feb-2020

Method: NCB Goods

1. The Government of India has received a Credit 5874-0-IN from the International Development Association and a Loan from the International Bank for Reconstruction and Development in various currencies towards the cost of _____ project and it is intended that part of the proceeds of this credit will be applied to eligible payments under the contracts for which this Invitation for Bids is issued.
2. The **TEQIP-III/OD/bpuo/21, BPUT/Odisha/G-17** now invites sealed bids from eligible bidders for supply of Packages listed below.
3. Interested Bidders may obtain further information on purchase of bid documents, time table for issue of bids and submission, cost of bid and methods of payments, bid security and pre bid meeting, from **TEQIP-III Cell of the Biju Patnaik University of Technology, Odisha, , India**, or visit the Institute website as per details below:
www.bput.ac.in (under TEQIP Link)

Address : **Biju Patnaik University of Technology, Odisha, Chhend, Rourkela, Odisha, Pin-769015**

Click here to download Bid Document

Sd/-
Co-ordinator TEQIP-III